KEY PARAMETERS

 V_{DRM}

I_{T(RMS)}

dVdt

dl/dt

tq

ITSM

DS4267-2.3

800V

130A

1600A

200V/us

500A/μs

7-10μs

DK13..FQ/W

FAST SWITCHING THYRISTOR

APPLICATIONS

- High Power Inverters And Choppers.
- UPS.
- AC Motor Drives.
- Induction Heating.
- Cycloconverters.

FEATURES

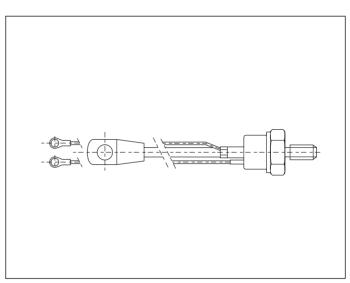
- Low Switching Losses At High Frequency.
- Fully Characterised For Operation Up To 20kHz.

VOLTAGE RATINGS

Type Number	Repetitive Peak Voltages V _{DRM} V V	Conditions
DK13 08FQ K or M DK13 06FQ K or M	800 600	$V_{RSM} = V_{RRM} + 100V$ $I_{DRM} = I_{RRM} = 15\text{mA}$
		at V_{RRM} or V_{DRM} & T_{vj}

 $Q = t_q 7\mu s. e.g. DK13 08FQK.$ $W = t_q 10\mu s. e.g. DK13 08FWK.$

For 1/2" 20 UNF thread add K to type number, e.g. DK13 06FWK. For M12 thread add M to type number, e.g. DK13 06FQM.



Outline type code: TO94 See package outlines for further information.

CURRENT RATINGS

Symbol	Parameter	Conditions	Max.	Units
I _{T(AV)}	Mean on-state current	Half wave resistive load, T _{case} = 80°C	83	Α
I _{T(RMS)}	RMS value	T _{case} = 80°C	130	Α

DK13..FQ/W

SURGE RATINGS

Symbol	Parameter	Conditions	Max.	Units
I _{TSM}	Surge (non-repetitive) on-state current	$t_p = 10$ ms half sine; $T_{case} = 125$ °C	1.6	kA
l ² t	I ² t for fusing	$V_{R} = 0\% V_{RRM} - 1/4 \text{ sine}$	12.8 x 10 ³	A²s

THERMAL AND MECHANICAL DATA

Symbol	Parameter	Conditions	Min.	Max.	Units
R _{th(j-c)}	Thermal resistance - junction to case	dc	-	0.25	°C/W
R _{th(c-h)}	Thermal resistance - case to heatsink	Mounting torque 15.0Nm with mounting compound	-	0.08	°C/W
T _{vj}	Virtual junction temperature	On-state (conducting)	-	125	°C
		Reverse (blocking)	-	125	°C
T _{stg}	Storage temperature range		-40	150	°C
-	Mounting torque		12.0	15.0	Nm

DYNAMIC CHARACTERISTICS

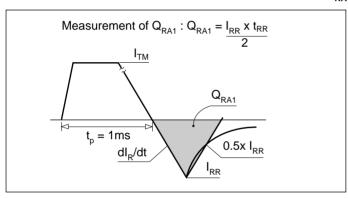
Symbol	Parameter	Conditions		Min.	Max.	Units
V _{TM}	Maximum on-state voltage	At 300A peak, T _{case} = 25°C		-	2.35	V
I _{RRM} /I _{DRM}	Peak reverse and off-state current	At V _{RRM} /V _{DRM} , T _{case} = 125°C	At V_{RRM}/V_{DRM} , $T_{case} = 125^{\circ}C$		15	mA
dV/dt	Maximum linear rate of rise of off-state voltage	Linear to 60% V_{DRM} T_j = 125°C, Gate open circuit		-	200	V/μs
11/1/		Gate source 20V, 20Ω	Repetitive 50Hz	-	500	A/μs
dl/dt		t _r < 0.5μs, T _j = 125°C	Non-repetitive	-	800	A/μs
V _{T(TO)}	Threshold voltage	At T _{vj} = 125°C		-	1.5	V
r _T	On-state slope resistance	At T _{vj} = 125°C		-	2.83	mΩ
t _{gd}	Delay time	$T_{j} = 25^{\circ}\text{C}, I_{T} = 50\text{A},$ $V_{D} = 300\text{V}, I_{G} = 1\text{A},$ $dI/dt = 50\text{A}/\mu\text{s}, dI_{G}/dt = 1\text{A}/\mu\text{s}$		1.5	-	μs
t _{(ON)TOT}	Total turn-on time			3	-	μs
I _H	Holding current	$T_{j} = 25^{\circ}C, I_{TM} = 1A, V_{D} = 12V$		60*	-	mA
		$T_{I} = 125^{\circ}C$, $I_{T} = 100A$, $V_{R} = 50V$, $t_{Q} = 100A$, $t_{Q} = 1$	-	7	μs	
t _q	Turn-off time	$dI_R/dt = 30A/\mu s$, Gate open circu	uit t _q code: W	-	10	μs

^{*}Typical value.

GATE TRIGGER CHARACTERISTICS AND RATINGS

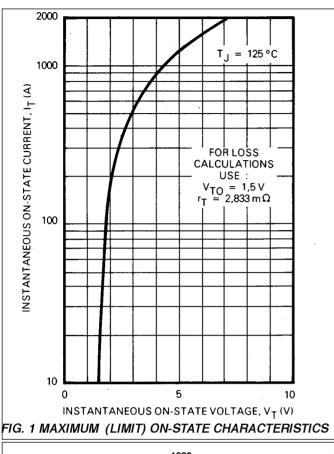
Symbol	Parameter	Conditions		Max.	Units
V _{GT}	Gate trigger voltage	$V_{DRM} = 12V, T_{case} = 25^{\circ}C, R_{L} = 6\Omega$	-	3.0	V
I _{GT}	Gate trigger current	$V_{DRM} = 12V, T_{case} = 25^{\circ}C, R_{L} = 6\Omega$	-	200	mA
V _{GD}	Gate non-trigger voltage	At V_{DRM} $T_{case} = 125^{\circ}C$, $R_{L} = 1k\Omega$	-	0.2	V
V _{RGM}	Peak reverse gate voltage		-	5.0	V
I _{FGM}	Peak forward gate current	Anode positive with respect to cathode	-	4	А
P _{GM}	Peak gate power		-	16	W
P _{G(AV)}	Mean gate power		-	3.0	W

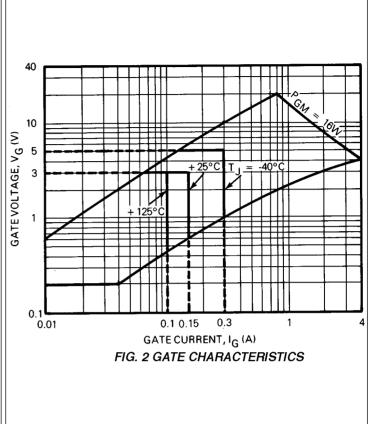
MEASUREMENT OF RECOVERED CHARGE - \mathbf{Q}_{RA1}

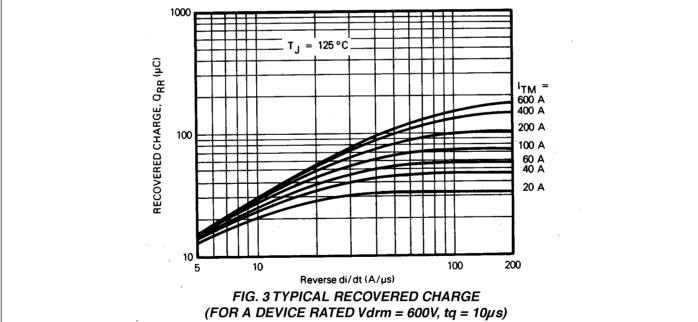


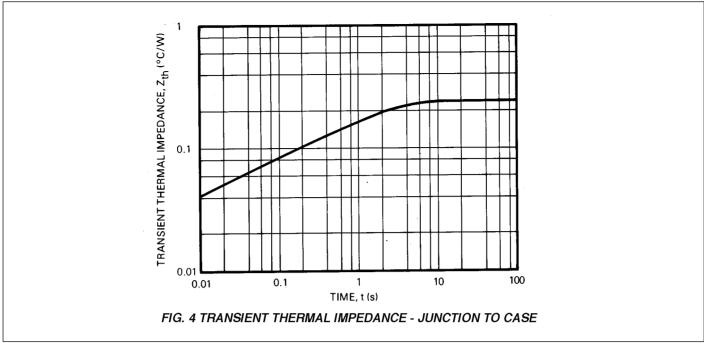
DK13..FQ/W

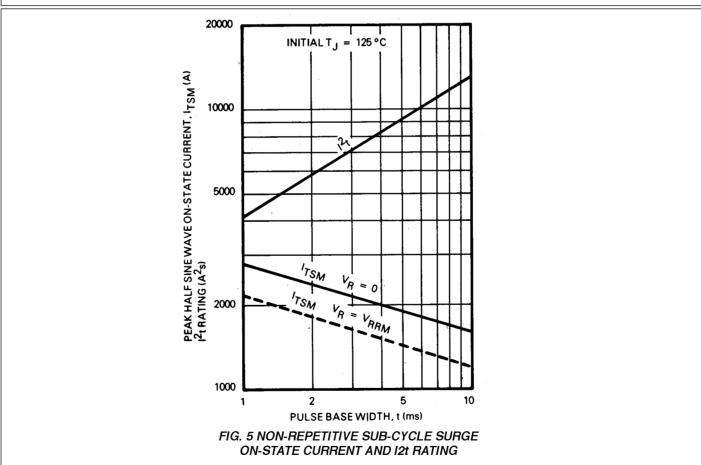
CURVES

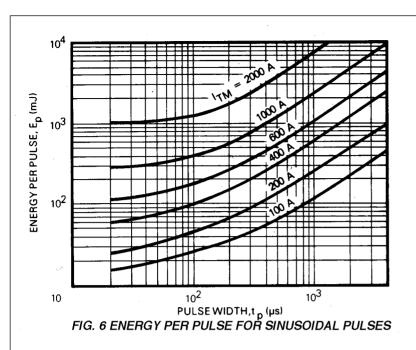




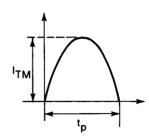








- 1. $V_D \le 600V$. 2. $V_R \le 10V$. 3. R.C Snubber, $C = 0.22\mu F$, $R = 4.7\Omega$



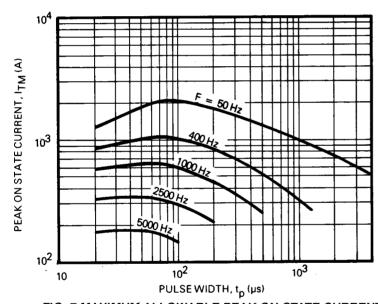
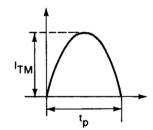


FIG. 7 MAXIMUM ALLOWABLE PEAK ON-STATE CURRENT vs PULSE WIDTH FOR Tc = 65°C

- 1. $V_D \le 600V$. 2. $V_R \le 10V$. 3. R.C Snubber, $C = 0.22\mu F$, $R = 4.7\Omega$



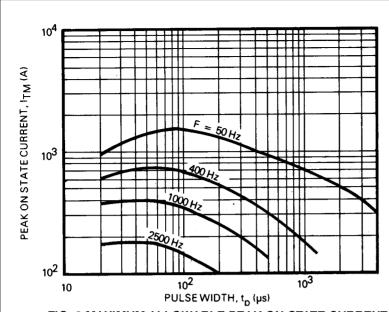
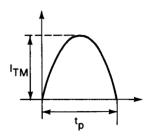
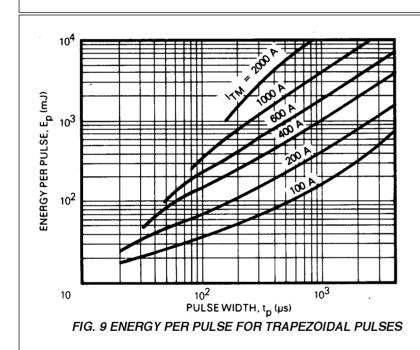


FIG. 8 MAXIMUM ALLOWABLE PEAK ON-STATE CURRENT vs PULSE WITDTH FOR Tc = 90°C

1. $V_D \le 600V$. 2. $V_R \le 10V$. 3. R.C Snubber, $C = 0.22\mu F$, $R = 4.7\Omega$

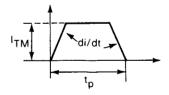




NOTES:

1. $dI/dt = 25A/\mu s$

1. $GRA = 26.3 \mu G$ 2. $V_D \le 600V$. 3. $V_R \le 10V$. 4. R.C Snubber, $C = 0.22 \mu F$, $R = 4.7 \Omega$



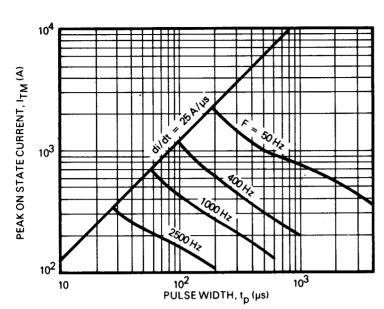
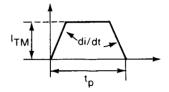
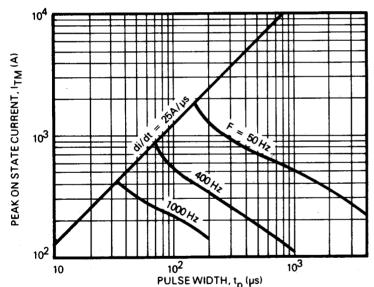


FIG. 10 MAXIMUM ALLOWABLE PEAK ON-STATE CURRENT vs PULSE WIDTH FOR Tc = 65°C

- 1. $dI/dt = 25A/\mu s$

- 2. $V_D \le 600V$. 3. $V_R \le 10V$. 4. R.C Snubber, $C = 0.22\mu F$, $R = 4.7\Omega$



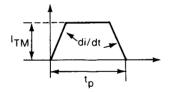


PULSE WIDTH, t_p (µs)

FIG. 11 MAXIMUM ALLOWABLE PEAK ON-STATE CURRENT vs PULSE WIDTH FOR Tc = 90°C

- 1. $dI/dt = 25A/\mu s$

- 2. $V_D \le 600V$. 3. $V_R \le 10V$. 4. R.C Snubber, $C = 0.22\mu F$, $R = 4.7\Omega$



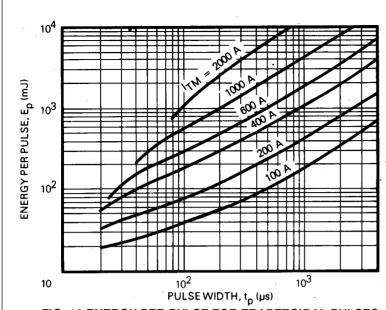
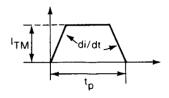


FIG. 12 ENERGY PER PULSE FOR TRAPEZOIDAL PULSES

NOTES:

- 1. $dI/dt = 50A/\mu s$

- 2. $V_D \le 600V$. 3. $V_R \le 10V$. 4. R.C Snubber, $C = 0.22\mu F$, $R = 4.7\Omega$



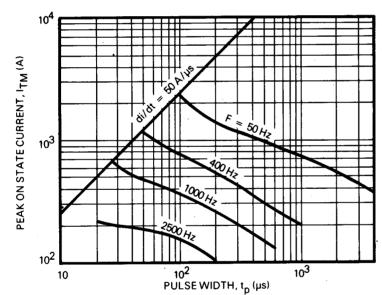
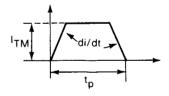


FIG. 13 MAXIMUM ALLOWABLE PEAK ON-STATE CURRENT vs PULSE WIDTH FOR Tc = 65°C

- 1. $dI/dt = 50A/\mu s$

- 2. $V_D \le 600V$. 3. $V_R \le 10V$. 4. R.C Snubber, $C = 0.22\mu F$, $R = 4.7\Omega$



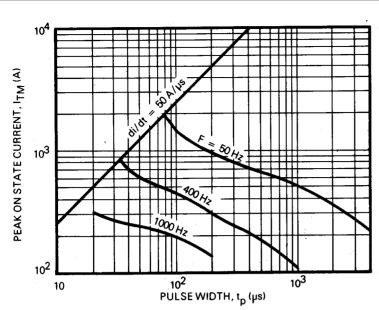
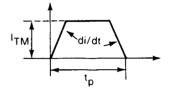


FIG. 14 MAXIMUM ALLOWABLE PEAK ON-STATE CURRENT vs PULSE WIDTH FOR Tc = 65°C

- 1. $dI/dt = 50A/\mu s$

- 2. $V_D \le 600V$. 3. $V_R \le 10V$. 4. R.C Snubber, $C = 0.22\mu F$, $R = 4.7\Omega$



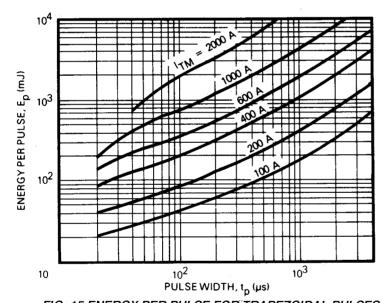
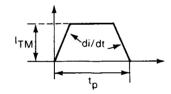


FIG. 15 ENERGY PER PULSE FOR TRAPEZOIDAL PULSES

- 1. $dI/dt = 100A/\mu s$

- 2. $V_D \le 600V$. 3. $V_R \le 10V$. 4. R.C Snubber, $C = 0.22\mu F$, $R = 4.7\Omega$



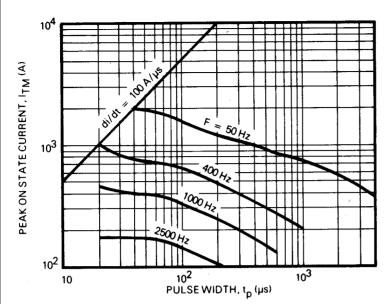


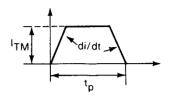
FIG. 16 MAXIMUM ALLOWABLE PEAK ON-STATE CURRENT vs PULSE WIDTH FOR Tc = 65°C

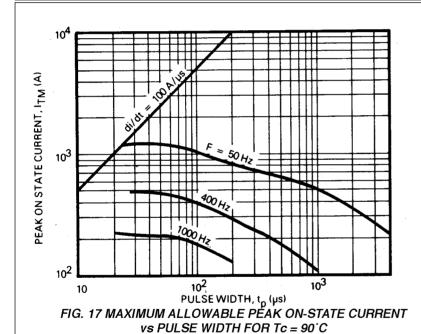
- 1. $dI/dt = 100A/\mu s$

NOTES:

1. $dI/dt = 100A/\mu s$

2. $V_D \le 600V$. 3. $V_R \le 10V$. 4. R.C Snubber, $C = 0.22\mu F$, $R = 4.7\Omega$

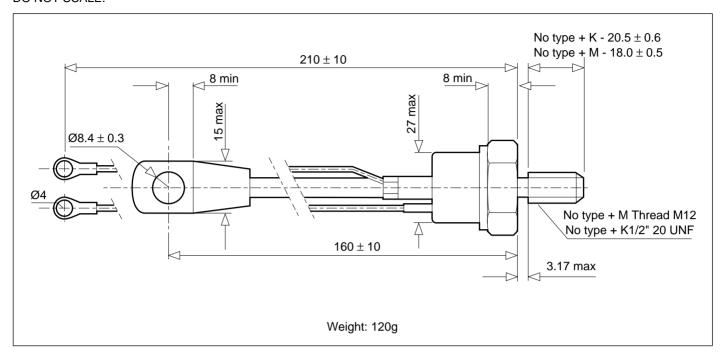




2. $V_D \le 600V$. 3. $V_R \le 10V$. 4. R.C Snubber, $C = 0.22\mu F$, $R = 4.7\Omega$

PACKAGE DETAILS - TO94

For further package information, please contact your local Customer Service Centre. All dimensions in mm, unless stated otherwise. DO NOT SCALE.





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